# SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74LS174, SN74LS175, SN74LS175, SN74S174, SN74LS175, SN74S175, SN74S174, SN74LS175, SN74S174, SN74LS175, SN74S174, SN74LS175, SN74LS175, SN74LS175, SN74LS175, SN74LS175, SN74LS176, SN54LS176, SN74LS176, SN74LS176, SN74LS176, SN74LS176, SN54LS176, SN

SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

'174, 'LS174, 'S174 . . . HEX D-TYPE FLIP-FLOPS '175, 'LS175, 'S175 . . . QUADRUPLE D-TYPE FLIP-FLOPS

- '174, 'LS174, 'S174 Contain Six Flip-Flops with Single-Rail Outputs
- '175, 'LS175, 'S175 Contain Four Flip-Flops with Double-Rail Outputs
- Three Performance Ranges Offered: See Table Lower Right
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications include:

   Buffer/Storage Registers
   Shift Registers
   Pattern Generators

#### description

These monolithic, positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. All have a direct clear input, and the '175, 'LS175, and 'S175 feature complementary outputs from each flip-flop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

These circuits are fully compatible for use with most TTL circuits.

FUNCTION TABLE (EACH FLIP-FLOP)

	NPUTS		OUT	PUTS
CLEAR CLOCK		D	Q	ā۲
L	X	Х	L	Н
н	1	н	н	L
н	1	L	L	Н
н	L	X	ao	$\bar{\alpha}_0$

H = high level (steady state)

L = low level (steady state)

X = irrelevant

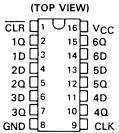
t = transition from low to high level

 $\Omega_0$  = the level of  $\Omega$  before the indicated steady-state input conditions were established.

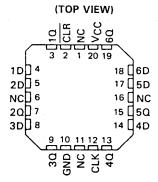
† = '175, 'LS175, and 'S175 only

	TYPICAL	TYPICAL
TYPES	MAXIMUM	POWER
TTFES	CLOCK	DISSIPATION
	FREQUENCY	PER FLIP-FLOP
'174, '175	35 MHz	38 mW
'LS174, 'LS175	40 MHz	14 mW
'S174, 'S175	110 MHz	75 mW

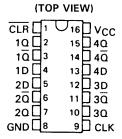
SN54174, SN54LS174, SN54S174 . . . J OR W PACKAGE SN74174 . . . N PACKAGE SN74LS174, SN74S174 . . . D OR N PACKAGE



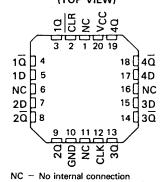
SN54LS174, SN54S174 . . . FK PACKAGE



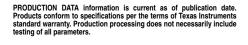
SN54175, SN54LS175, SN54S175 . . . J OR W PACKAGE SN74175 . . . N PACKAGE SN74LS175, SN74S175 . . . D OR N PACKAGE



SN54LS175, SN54S175 . . . FK PACKAGE (TOP VIEW)



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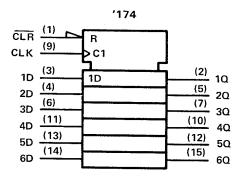


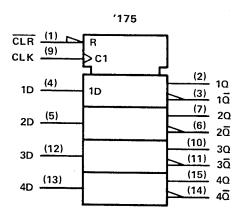


# SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74LS174, SN74LS175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

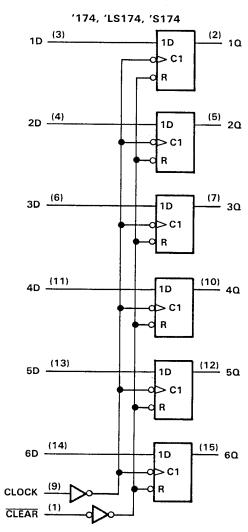
#### logic symbols†

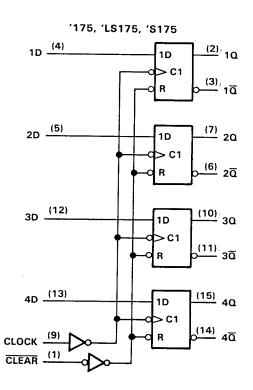




<sup>&</sup>lt;sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

#### logic diagrams (positive logic)





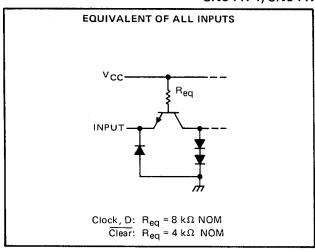
Pin numbers shown are for D, J, N, and W packages.

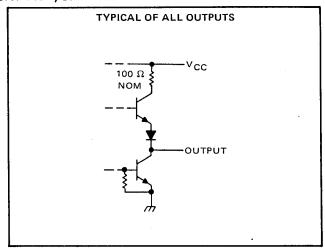


SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

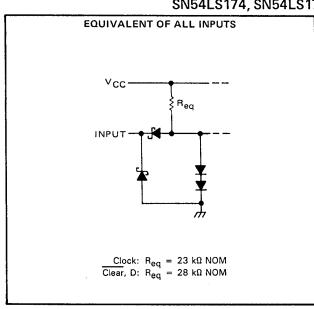
#### schematics of inputs and outputs

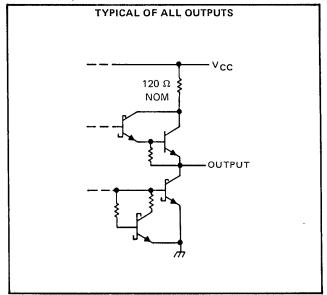
#### SN54174, SN54175, SN74174, SN74175



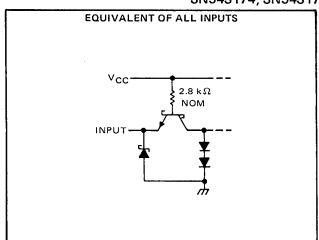


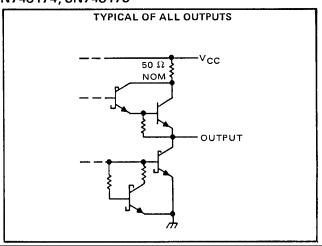
SN54LS174, SN54LS175, SN74LS174, SN74LS175





SN54S174, SN54S175, SN74S174, SN74S175







### SN54174, SN54175, SN74174, SN74175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1) .		 	7 V
Input voltage		 	5.5 V
Operating free-air temperature range:	SN54174, SN54175 Circuits	 5	55°C to 125°C
, ,	SN74174, SN74175 Circuits	 	0°C to 70°C
Storage temperature range			65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN54	174, SN	54175	SN74	174, SN	74175	LINIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH				-800			-800	μΑ
Low-level output current, IOL				16			16	mA
Clock frequency, f <sub>clock</sub>		0		25	0		25	MHz
Width of clock or clear pulse, t <sub>W</sub>		20			20			ns
Setup time, t <sub>su</sub>	Data input	20			20			ns
Setup time, tsu	Clear inactive-state	25			25			ns
Data hold time, t <sub>h</sub>		5			5			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS <sup>†</sup>	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage		2			<b>V</b>
VIL	Low-level input voltage				0.8	>
VIK	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = -12 mA			-1.5	>
Vон	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -800 μA	2.4	3.4		٧
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4	٧
l <sub>1</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V			1	mA
ΊΗ	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V			40	μΑ
IL	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V			-1.6	mA
1	Chart in it automatical 8	SN SN	54' -20		-57	^
los	Short-circuit output current §	V <sub>CC</sub> = MAX	74' –18		-57	mA
laa	Cumple guerrant	VCC = MAX. See Note 2 '17	74	45	65	
1CC	Supply current	V <sub>CC</sub> = MAX, See Note 2 /17	75	30	45	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, ICC is measured after a momentary ground, then 4.5 V, is applied to clock.

#### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>	Maximum clock frequency		25	35		MHz
tPLH	Propagation delay time, low-to-high-level output from clear (SN54175, SN74175 only)	C <sub>L</sub> = 15 pF,		16	25	ns .
tPHL.	Propagation delay time, high-to-low-level output from clear	$R_L$ = 400 Ω, See Note 3		23	35	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		20	30	ns
tPHL	Propagation delay time, high-to-low-level output from clock			24	35	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>\</sup>ddagger$ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>§</sup>Not more than one output should be shorted at a time.

#### SN54LS174, SN54LS175, SN74LS174, SN74LS175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)					 		7 V
Input voltage							
Operating free-air temperature range:	SN54LS174	, SN54LS175 (	Circuits .		 		–55°C to 125°C
	SN74LS174	, SN74LS175 (	Circuits .	. · .	 		. 0°C to 70°C
Storage temperature range							-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN	154LS1	74	SN	174LS1	74	
		SN	N54LS1	75	SI	174LS1	75	UNIT
		MIŃ	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-400			-400	μА
Low-level output current, IOL				4		·	8	mA
Clock frequency, fclock		0		30	0		30	MHz
Width of clock or clear pulse, t <sub>W</sub>		20			20			ns
Satura tima	Data input	20			20			ns
Setup time, t <sub>su</sub>	Clear inactive-state	25			25			ns
Data hold time, th		5			5			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TES	T CONDITIONS	t	_	N54LS1 N54LS1		_	N74LS N74LS		UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage				2			2			٧
$v_{IL}$	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA				-1.5			-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max	V <sub>IH</sub> = 2 V, , I <sub>OH</sub> = -400 μ,	Α	2.5	3.5		2.7	3.5		٧
V	Louise outros vales -	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	
VOL	Low-level output voltage	VIL = VIL max	•	IOL = 8 mA					0.35	0.5	٧
łį	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
Чн	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V			· · · · · · · · · · · · · · · · · · ·	20			20	μА
IJĽ	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V <sub>CC</sub> = MAX			-20		-100	-20		-100	mA
loo	Supply current	V MAY	Coo Note 2	'LS174		16	26		16	26	1
¹cc	Supply culterit	V <sub>CC</sub> = MAX,	See Note 2	'LS175		11	18		11	18	mA

<sup>1</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS		'LS174	•		'LS175		
FARAMETER	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
f <sub>max</sub> Maximum clock frequency		30	40		30	40		MHz
tplH Propagation delay time, low-to-high-level output from clear	C <sub>L</sub> = 15 pF,				-	20	30	ns
tpHL Propagation delay time, high-to-low-level output from clear	$R_{L} = 2 k\Omega$		23	35	İ	20	30	ns
tPLH Propagation delay time, low-to-high-level output from clock	See Note 3		20	30		13	25	ns
tphl Propagation delay time, high-to-low-level output from clock			21	30		16	25	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



 $<sup>^{\</sup>dagger}$  All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25^{\circ}\text{C}$ .

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I<sub>CC</sub> is measured after a momentary ground, then 4.5 V, is applied to clock.

### SN54S174, SN54S175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

SDLS068A - DECEMBER 1972 - REVISED OCTOBER 2001

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)			 	 	 7 V
Input voltage			 	 	 5.5 V
Operating free-air temperature range	: SN54S174, SI	N54S175 Circuits	 	 	 -55°C to 125°C
,	SN74S174, SI	N74S175 Circuits	 	 	 . 0°C to 70°C
Storage temperature range					-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN549	174, SN	54S175	SN745	174, SN	74S175	LINIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-1			-1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, f <sub>clock</sub>		0		75	0		75	MHz
Dules width +	Clock	7			7			
Pulse width, t <sub>W</sub>	Clear	10			10			ns
Cotun Aires A	Data input	5			5			T
Setup time, t <sub>SU</sub>	Clear inactive-state	5			5			ns
Data hold time, t <sub>h</sub>		3			3			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
$v_{IK}$	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA				-1.2	V
	High level automaticalisms	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,	SN54S'	2.5	3.4		V
VOH	High-level output voltage	V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -1 mA	SN74S'	2.7	3.4		) V
V	Low level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,				0.5	V
VOL	Low-level output voltage	V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA				0.5	ľ
Ц	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V				1	mA
ЧΗ	High-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.7 V				50	μΑ
11L	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V				-2	mA
los	Short-circuit output current §	V <sub>CC</sub> = MAX		-40		-100	mA
la-	6 1	VMAY See Note 2	′174		90	144	
Icc	Supply current	V <sub>CC</sub> = MAX, See Note 2		60	96	mA	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

#### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>	Maximum clock frequency		75	110		MHz
tPLH	Propagation delay time, low-to-high-level $\overline{\mathbb{Q}}$ output from clear (SN54S175, SN74S175 only)	C <sub>L</sub> = 15 pF,		10	15	ns
tPHL.	Propagation delay time, high-to-low-level Q output from clear	$R_L = 280 \Omega$ , See Note 3		13	22	ns
<sup>t</sup> PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		8	12	ns
†PHL	Propagation time, high-to-low-level output from clock			11.5	17	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. \$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I<sub>CC</sub> is measured after a momentary ground, then 4.5 V, is

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30-Sep-2023

#### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07105BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
JM38510/07105BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
JM38510/07106BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
JM38510/30106B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
JM38510/30106BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
JM38510/30106BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
JM38510/30107B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples
JM38510/30107BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
JM38510/30107BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
M38510/07105BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BEA	Samples
M38510/07105BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07105BFA	Samples
M38510/07106BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07106BEA	Samples
M38510/30106B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106B2A	Samples
M38510/30106BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BEA	Samples
M38510/30106BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30106BFA	Samples
M38510/30107B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107B2A	Samples





30-Sep-2023 www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
M38510/30107BEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BEA	Samples
M38510/30107BFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30107BFA	Samples
SN54LS174J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS174J	Samples
SN54LS175J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS175J	Samples
SN54S174J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S174J	Samples
SN54S175J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S175J	Samples
SN74LS174D	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS174	
SN74LS174DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS174	Samples
SN74LS174N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS174N	Samples
SN74LS174NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS174	Samples
SN74LS175D	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS175	
SN74LS175DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS175	Samples
SN74LS175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Samples
SN74LS175NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS175N	Samples
SN74LS175NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS175	Samples
SN74S175D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S175	Samples
SN74S175N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S175N	Samples
SNJ54LS174FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 174FK	Samples
SNJ54LS174J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174J	Samples
SNJ54LS174W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS174W	Samples

www.ti.com 30-Sep-2023

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS175FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 175FK	Samples
SNJ54LS175J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175J	Samples
SNJ54LS175W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS175W	Samples
SNJ54S174J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174J	Samples
SNJ54S174W	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S174W	Samples
SNJ54S175J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S175J	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

#### **PACKAGE OPTION ADDENDUM**

www.ti.com 30-Sep-2023

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#### OTHER QUALIFIED VERSIONS OF SN54LS174, SN54LS175, SN54S175, SN74LS174, SN74LS175, SN74S175:

• Catalog: SN74LS174, SN74LS175, SN74S175

Military: SN54LS174, SN54LS175, SN54S175

NOTE: Qualified Version Definitions:

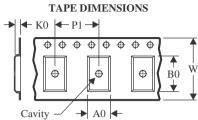
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

### **PACKAGE MATERIALS INFORMATION**

www.ti.com 1-Jul-2023

#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

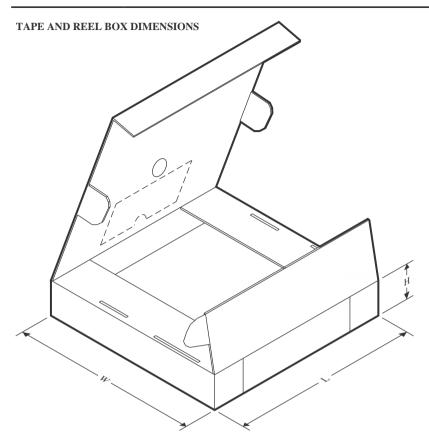
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS174DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS174NSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS175DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS175NSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

www.ti.com 1-Jul-2023



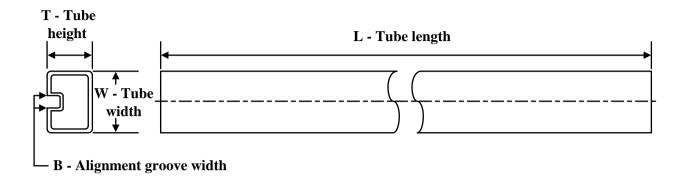
#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS174DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS174NSR	SO	NS	16	2000	356.0	356.0	35.0
SN74LS175DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS175NSR	so	NS	16	2000	356.0	356.0	35.0



www.ti.com 1-Jul-2023

#### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/07105BFA	W	CFP	16	1	506.98	26.16	6220	NA
JM38510/30106B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30106BFA	W	CFP	16	1	506.98	26.16	6220	NA
JM38510/30107B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30107BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/07105BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/30106B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30106BFA	W	CFP	16	1	506.98	26.16	6220	NA
M38510/30107B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30107BFA	W	CFP	16	1	506.98	26.16	6220	NA
SN74LS174D	D	SOIC	16	40	507	8	3940	4.32
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175D	D	SOIC	16	40	507	8	3940	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS175NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175D	D	SOIC	16	40	507	8	3940	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74S175N	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS174FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS174W	W	CFP	16	1	506.98	26.16	6220	NA
SNJ54LS175FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS175W	W	CFP	16	1	506.98	26.16	6220	NA

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